

TE0706 TRM

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Overview

The Trencz Electronic TE0706 Carrier Board provides functionalities for testing, evaluation and development purposes of company's 4 x 5 cm SoMs. The Carrier Board is equipped with various components and connectors for different configuration setups and needs. The interfaces of the SoM's functional units and PL I/O-banks are connected via board-to-board connectors to the Carrier Board's components and connectors for easy user access.

See "[4 x 5 SoM Carriers](#)" page for more information about supported 4 x 5 cm SoMs.

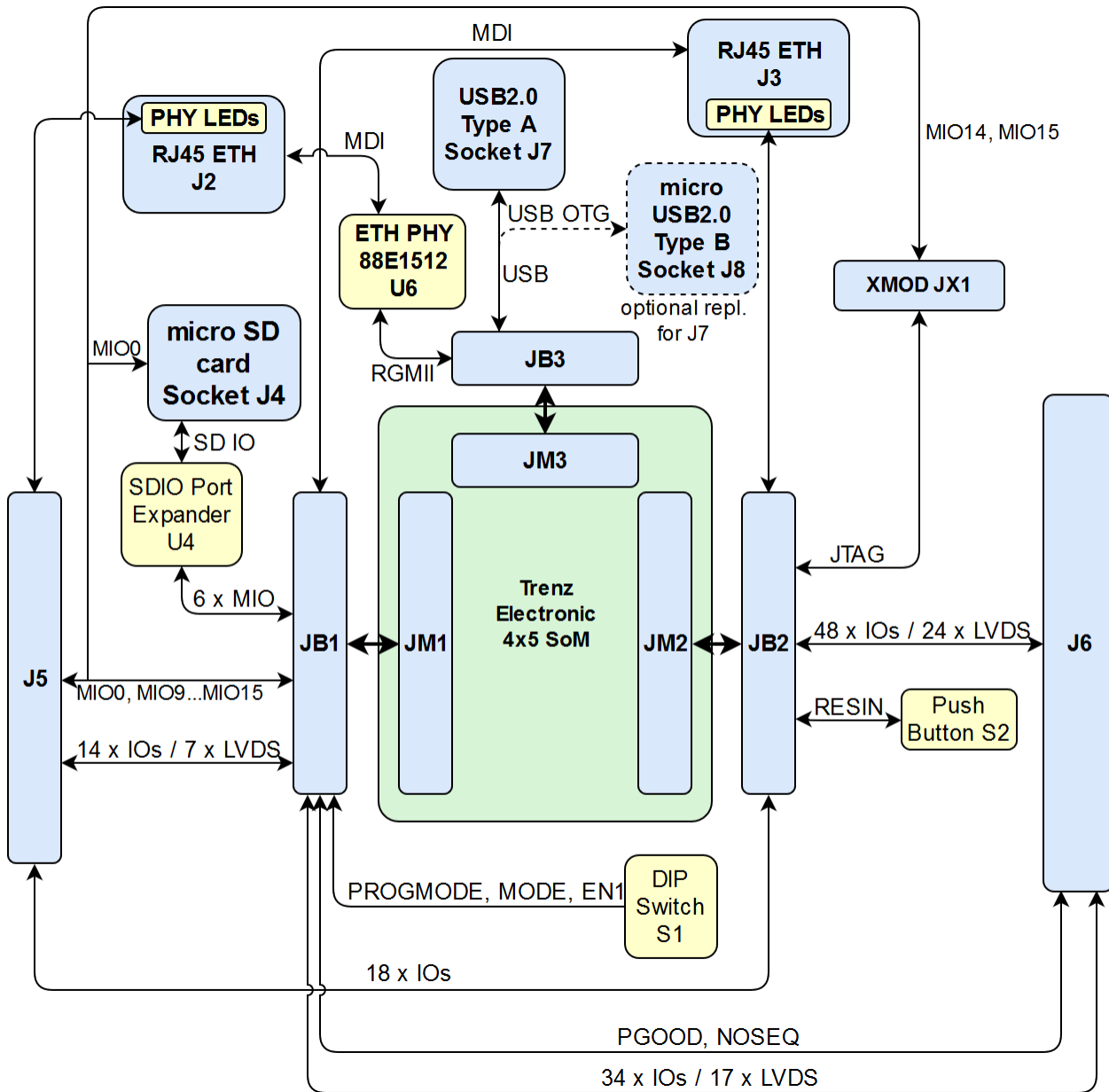
Refer to <http://trenz.org/te0706-info> for the current online version of this manual and other available documentation.

Key Features

- 3 x Samtec LSHM Series Board to Board Connectors
- VG96 connector (mounting holes and solder pads, J6) and 50-pin IDC male connector socket (J5) for access to PL I/O-bank pins
- USB2.0 type A connector, or optionally Micro USB 2.0 connector
- 1 x RJ45 GbE MagJack (J3), connected via MDI to B2B connector JB1
- 1 x Marvell Alaska 88E1512 GbE PHY, providing Ethernet interface in conjunction with RJ45 GbE MagJack (J2)
- 4 A High-Efficiency Power SoC DC-DC Step-Down Converter (Enpirion EN6347) for 3.3V power supply
- XMOD JTAG- / UART-header JX1
- Micro SD card socket
- SDIO port expander with voltage-level translation and jumper (J13) for selection of SDIO voltage on SoM side
- DIP-switches S1 to set SoM's control signals
- 1 x user-push button (S2), by default configured as system reset button
- 3 x VCCIO selection jumper J10, J11 and J12 to set SoM's PL I/O-bank voltages
- 5V power supply barrel jack

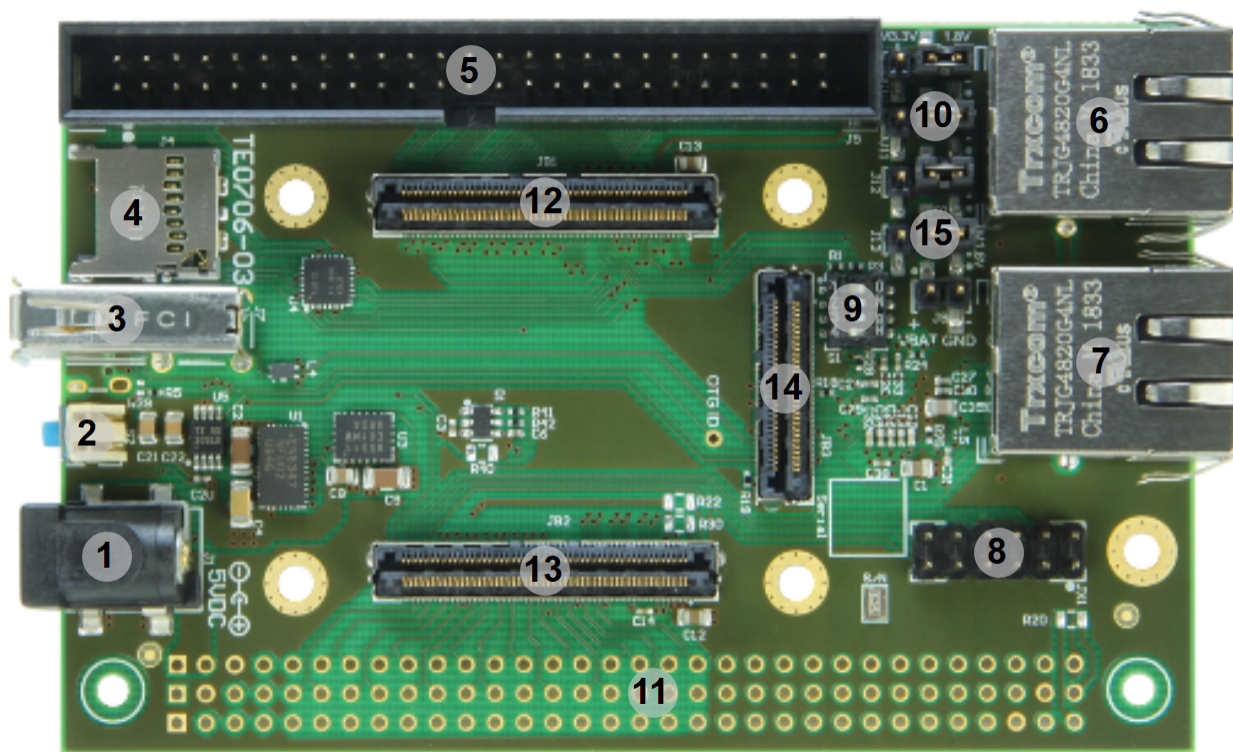
Additional assembly options are available for cost or performance optimization upon request.

Block Diagram



TE0706 block diagram

Main Components



TE0706 main components

1. 5V power connector jack, J1
2. Reset switch, S2
3. USB2.0 type A receptacle, J7
4. Micro SD card socket with Card Detect, J4
5. 50 pin IDC male connector, J5
6. 1000Base-T Gigabit RJ45 Ethernet MagJack, J3
7. 1000Base-T Gigabit RJ45 Ethernet MagJack, J2
8. XMOD JTAG- / UART-header, JX1
9. User DIP-switch, S1
10. VCCIO selection jumper block, J10 - J12
11. External connector (VG96) placeholder, J6
12. Samtec Razor Beam™ LSHM-150 B2B connector, JB1
13. Samtec Razor Beam™ LSHM-150 B2B connector, JB2
14. Samtec Razor Beam™ LSHM-130 B2B connector, JB3
15. SoM SDIO voltage selection jumper, J13

Initial Delivery State

There is no hardware component to be programmed on the carrier.

Storage device name	Content	Notes
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Initial delivery state of programmable devices on the module

Board is shipped in following configuration:

- VCCIO voltage selection jumpers are all set to 1.8 V.
- S2 switch configured as reset button.

Different delivery configurations are available upon request.

Configuration Signals

Signal	Designator	B2B	State	Description	Note
MODE	S1-3	JB1-31	ON	Drive SoM SC CPLD pin 'MODE' low.	Usually SD-Boot
			OFF	Leave SoM SC CPLD pin 'MODE' open.	Usually QSPI-Boot
EN1	S1-4	JB1-27	ON	Drive SoM SC CPLD pin 'EN1' low.	Usually used to enable/disable FPGA core-voltage supply. (Depends also on SoM's SC CPLD firmware). Note: Power-on sequence will be intermitted if S1-4 is set to OFF and if functionality is supported by SoM.
			OFF	Drive SoM SC CPLD pin 'EN1' high.	

Boot process.

There is a user push button which is used for RESET signal.

Signal	Designator	B2B	Note
RESIN	S2	JB2-17	Aktive Low

Reset process.

Signals, Interfaces and Pins

Board to Board (B2B) I/Os

With the TE0706 Carrier Board's Board-to-Board Connectors (B2B) the MIO- and PL I/O-bank's pins and further interfaces of the mounted SoM can be accessed. A large quantity of these I/Os are also usable as LVDS-pairs. The connectors provide also VCCIO voltages to operate the I/Os properly.

Following table gives a summary of the available I/Os, interfaces and LVDS-pairs of the B2B connectors JB1, JB2 and JB3:

B2B Connector	Interfaces	Count of I/Os	Notes
JB1	User I/O	48 single ended or 24 differential	-
		8 single ended	MIO with Zynq Modules
	GbE MagJack J3 MDI	8	-
	SD IO	6	-
	SoM control signals	5	EN1, PGOOD, MODE, NOSEQ, PRPGMODE
JB3	GbE PHY U6 RGMII	18	-
	USB2.0 (OTG, device and host mode)	5	-
JB2	User I/O	18 single ended	-
		48 single ended or 24 differential	-
	JTAG	4	-
	SoM control signals	1	RESIN

	GbE MagJack J3 LEDs	2	-
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Board to Board signals

On-board Connector

The TE0706 Carrier Board has a 50-pin IDC male connector J5 and soldering pads as place-holder to mount a VG96 connectors J6 to get access the PL I/O-bank's pins and further interfaces of the mounted SoM. With these connectors, SoM's PL-I/Os are available to the user, a large quantity of these I/Os are also usable as differential pairs.

Following table gives a summary of the pin-assignment, available interfaces and functional I/Os of the connectors J5 and J6:

On-board Connector	Control Signals and Interfaces	Count of I/Os	Notes
J5	User I/O	18 single ended	-
		14 single ended or 7 differential	-
	MIO	8	-
	GbE MagJack J2 LEDs	2	-
J6	User I/O	82 single ended or 41 differential	-
	SoM control signals	2	'PGOOD', 'NOSEQ'

Overview of PL IO signals, SoMs interfaces and control signals connected to the on-board connectors.

JTAG/UART Interface Base

JTAG/UART access to the TE0706 carrier is available through XMOD header JX1, which has a 'XMOD FTDI JTAG Adapter'-compatible pin-assignment. This header provides also a UART interface, usually established by MIO-pins of the PS-bank of the mounted SoM's Zynq device. XMOD USB2.0 to JTAG/UART adapter TE0790 is provided by Trenz Electronic. More information is available [here](#). Devices of the mounted SoM can be programed via USB2.0 interface.

XMOD Designator	Designator	B2B Pin	XMOD Header JX1	Note
3.3V	-	-	JX1-5	NC
A	MIO15	JB1-86	JX1-3	UART Txd - (transmit line)
B	MIO14	JB1-91	JX1-7	UART Rxd - (receive line)
C	TCK_B	JB2-100	JX1-4	JTAG-TCK
D	TDO_B	JB2-98	JX1-8	JTAG-TDO
E	XMOD_E	-	-	NC
F	TDI_B	JB2-96	JX1-10	JTAG-TDI
G	XMOD_G	-	-	NC
H	TMS_B	JB2-94	JX1-12	JTAG-TMS
VIO	VCCJTAG	JB2-92	JX1-6	VIO is connected to 3.3V which is supplied by carrier

JTAG interface Base

When using XMOD FTDI JTAG Adapter TE0790, the adapter-board's VIO will be sourced by the mounted SoM's 'VCCJTAG' (pin JB2-92). Set the DIP-switch with the setting:

XMOD DIP-switches	Position
Switch 1	ON

Switch 2	OFF
Switch 3	OFF
Switch 4	ON

XMOD adapter board DIP-switch positions for voltage configuration



Use AMD compatible TE0790 adapter board (designation TE-0790-xx with out 'L') to program the AMD Zynq devices.

The TE0790 adapter board's CPLD have to be configured with the **Standard** variant of the firmware. Refer to the [TE0790 Resources Site](#) for further information and firmware download.

SD Card Socket

The SD Socket is routed to the on-board Texas Instruments TXS02612 SDIO port expander U4. This IC provides a necessary VDD/VCCIO translation between the MicroSD Card socket J4 (3.3V) and the SoM's Zynq device MIO-bank (1.8V/3.3V depending on Module, compare [jumper J13](#)):

SD IO Signal Schematic Name	Connected to	Note
eSD_DAT0	U4-18	SD IO data
eSD_DAT1	U4-16	SD IO data
eSD_DAT2	U4-23	SD IO data
eSD_DAT3	U4-22	SD IO data
eSD_CLK	U4-19	SD IO clock
eSD_CMD	U4-20	SD IO command
MIO0	J5-29	Card Detect signal

SD IO interface signals

USB2.0 connector

TE0706-03 board has one physical USB2.0 type A socket J7, the differential data signals of the USB2.0 socket are routed to the B2B connector JB3, where they can be accessed by the corresponding USB2.0 PHY transceiver of the mounted SoM.

There is also the option to equip the board with a Micro USB 2.0 type B (receptacle) socket (J8) to the board as alternative fitting option. With this fitting option (Micro USB2.0 type B), the USB2.0 interface can also be used for Device mode, OTG and Host Modes.

For USB2.0 Host mode, the Carrier Board is additionally equipped with a power distribution switch U5 to provide the USB2.0 interface with the USB supply voltage USB-VBUS with nominal value of 5V. OTG mode is not available with USB2.0 Type A socket.

Following table gives an overview of the USB2.0 connector signals:

USB2.0 Signal Schematic Name	B2B	Connected to (type A)	Connected to (optional replacement for type A J7)	Note
OTG-D_N	JB2-48	J7-2	J8-2	USB2.0 data
OTG-D_P	JB2-50	J7-3	J8-3	USB2.0 data
OTG-ID	JB2-52	NC	J8-4	Ground this pin for A-Device (host), left floating this pin for B-Device (peripheral).
VBUS_V_EN	JB2-54	U5-4	U5-4	Enable USB-VBUS.
USB-VBUS	JB2-56	J7-1	J8-1	USB supply voltage in Host mode.

USB2.0 interface signals and connections

RJ45 Gigabit Ethernet Connectors

The TE0706 Carrier Board is equipped with two Gigabit Ethernet ports. One of them (J2) is routed to Marvell Alaska 88E1512 Gigabit Ethernet PHY (U6). The GbE MegJack J2 has two integrated LEDs (both green), its signals are routed as MDI (Media Dependent Interface) to the GbE PHY. The MegJack J3 is connected via MDI directly to the B2B connector JB1. There is usually a corresponding Gigabit Ethernet PHY on 4 x 5 SoMs (e.g. TE0715 or TE0720), which can be used in conjunction with the baseboard MegJack J3.

MegJack J2	Signal	Connected to
J2-2	PHY2_MDIO_P	U6-28
J2-3	PHY2_MDIO_N	U6-27
J2-4	PHY2_MDIO1_P	U6-24
J2-5	PHY2_MDIO1_N	U6-23
J2-6	PHY2_MDIO2_P	U6-22
J2-7	PHY2_MDIO2_N	U6-21
J2-8	PHY2_MDIO3_P	U6-18
J2-9	PHY2_MDIO3_N	U6-17
J2 Green MegJack LED	PHY_LED0	U6-14
J2 Green MegJack LED	PHY_LED1	U6-13

RJ45 connectors J2

MegJack J3	Signal	B2B
J3-2	PHY_MDIO_P	JB1-3
J3-3	PHY_MDIO_N	JB1-5
J3-4	PHY_MDIO1_P	JB1-9
J3-5	PHY_MDIO1_N	JB1-11
J3-6	PHY_MDIO2_P	JB1-15
J3-7	PHY_MDIO2_N	JB1-17
J3-8	PHY_MDIO3_P	JB1-21
J3-9	PHY_MDIO3_N	JB1-23
J3 Green MegJack LED	ETH_LED1	JB2-90
J3 Yellow MegJack LED	ETH_LED2	JB2-99

RJ45 connectors J3

MIO Pins

Signal (MIO Pin)	Connected to	B2B	Notes
MIO0	micro SD-Card, J5-29	JB1-88	Card detect
MIO9	J5-30	JB1-92	

MIO10	J5-28	JB1-96	I ² C clock line
MIO11	J5-27	JB1-94	I ² C data line
MIO12	J5-26	JB1-100	
MIO13	J5-25	JB1-98	
MIO14	XMOD, J5-32	JB1-91	UART
MIO15	XMOD, J5-31	JB1-86	
6 x MIO	SD-Card	JB1	B2B positions see SDIO Port Expander . MIO positions depend on attached SoM.

MIOs pins

On-board Peripherals

Chip/Interface	Designator	Notes
4-bit DIP-switch	S1	Bit 1 not connected
VCC Selection Jumper	J10-J13	VCCIOA, VCCIOB, VCCIOC, SD_VCCA
RTC Buffer Voltage Supply Header	J9	
Push Button	S2	
Gigabit Ethernet PHY	U6	
SDIO Port Expander	U4	

On board peripherals

4-bit DIP-switch

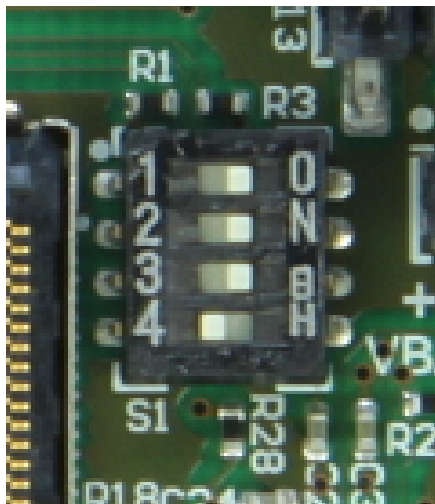
Table below describes DIP-switch S1 settings for configuration of the mounted SoM:

Switch	Signal Name	ON	OFF	Notes
S1-1	-	-	-	Not connected.
S1-2	PROGMO DE	JTAG enabled for programing mounted SoM's Zynq-SoC.	JTAG enabled for programing mounted SoM's SC-CPLD.	-
S1-3	MODE	Drive SoM SC CPLD pin 'MODE' low. (SD-Boot)	Leave SoM SC CPLD pin 'MODE' open. (QSPI-Boot)	Boot mode configuration, if supported by SoM. (Depends also on SoM's SC-CPLD firmware).
S1-4	EN1	Drive SoM SC CPLD pin 'EN1' low.	Drive SoM SC CPLD pin 'EN1' high.	Usually used to enable/disable FPGA core-voltage supply. (Depends also on SoM's SC CPLD firmware). Note: Power-on sequence will be intermitted if S1-4 is set to OFF and if functionality is supported by SoM.

DIP-switch SoM configuration settings




Note: Compared to the former revision 02 of this board, the DIP-switch is rotated by 180° due to routing issues.



User DIP-switch S1

VCC Selection Jumpers



Note: The corresponding PL I/O-bank supply-voltages of the 4 x 5 SoM to the selectable base-board voltages VCCIOA, VCCIOB and VCCIOC are depending on the mounted 4 x 5 SoM and varying in order of the used model.

Refer to the SoM's schematic for information about the specific pin assignments on module's B2B-connectors regarding the PL I/O-bank supply-voltages and to the [4 x 5 Module integration Guide](#) for VCCIO voltage options.

The Carrier Board VCCIO for the PL I/O-banks of the mounted SoM are selectable by the jumpers J10, J11 and J12.

Following table describes how to configure the VCCIO of the SoM's PL I/O-banks with jumpers:

Voltage Level	Supply Voltage by Jumper		Supply Voltage by 0-Ohm Resistor		Supply Connector Pin	Supplied Connector Pin
	1.8V	3.3V	1.8V	3.3V		
VCCIOA	J10: 1-2, 3	J10: 1, 2-3	-	R20	J6-B32	JB1-10, JB1-12
VCCIOB	J11: 1-2, 3	J11: 1, 2-3	R29	R21	-	JB2-6
VCCIOC	J12: 1-2, 3	J12: 1, 2-3	R30	R22	J6-B1	JB2-8, JB2-10

VCCIO jumper settings

Only one supply-source is allowed to configure the base-board supply-voltages, either by jumper, by 0-Ohm-resistor or by connector J6. If a supply-voltage is configured by 0-Ohm-resistor or connector J6, then the corresponding configuration-jumper has to be removed. There aren't 0-Ohm-resistors and supply-voltages by connector J6 allowed if the corresponding base-board supply-voltage is configured by jumper. Vice versa jumpers and 0-Ohm-resistors have to be removed if supplying corresponding base-board supply-voltage by connector J6.

Note: If supplying base-board supply-voltages by connector J6, the module's internal 3.3V voltage-level on pins 9 and 11 of B2B-connector JB2 has to be reached stable state.



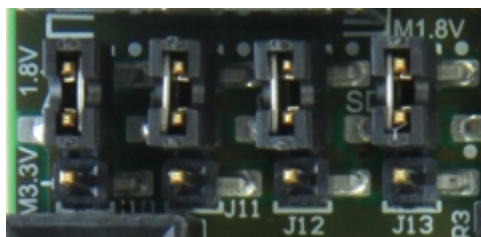
Take care of the VCCO voltage ranges of the particular PL IO-banks (HR, HP) of the mounted SoM, otherwise damages may occur to the FPGA. Therefore, refer to the TRM of the mounted SoM to get the specific information of the voltage ranges.

It is recommended to set and measure the PL IO-bank supply-voltages before mounting of TE 4 x 5 module to avoid failures and damages to the functionality of the mounted SoM.

The SDIO voltage on the SoM side can be selected by jumper J13.

Voltage Level	Supply Voltage by Jumper		Supplied Connector Pin
	1.8V	3.3V	
SD_VCCA	J13: 1-2, 3	J13: 1, 2-3	U4-5

SD Card jumper settings



Base-board supply-voltages (VCCIOA, VCCIOB, VCCIOC, SD_VCCA) selection jumpers

RTC Buffer Voltage Supply Header

The buffer voltage of the SoM's RTC can be supplied through the header J9 (VBAT-pin). Refer to the SoM's TRM for recommended voltage range and absolute maximum ratings.


Push Button

The Carrier Board's push button S2 is connected to the 'RESIN' signal, the function of the button is to trigger a reset of the mounted SoM by driving the reset-signal 'RESIN' to ground.

Gigabit Ethernet PHY

The TE0706 Carrier Board is equipped with a Marvell Alaska 88E1512 Gigabit Ethernet PHY (U6), which provides in conjunction with the Gigabit Ethernet MagJack J2 a 1000Base-T Ethernet (GbE) interface. The Ethernet PHY RGMII interface is connected to the B2B connector JB3, where they can be accessed by the mounted SoM's PS bank. The I/O Voltage is fixed at 1.8V. Reference clock input of the PHY is supplied from the on-board 25.000000 MHz oscillator (U7), the 125MHz output clock signal 'CLK125' is connected to the B2B connector pin JB3-32.

PHY U6 pins	B2B-pin	Notes
ETH-MDC/ETH-MDIO	JB3-49, JB3-51	-
PHY_LED0	-	Connected to GbE MagJack J2 LED0 (green). Also connected to J5-24 (PHY_LED0_CON).
PHY_LED1	-	Connected to GbE MagJack J2 LED1 (green). Also connected to J5-23 (PHY_LED1_CON).
PHY_INT	JB3-33	-

CONFIG	JB3-60	-
CLK125	JB3-32	PHY Clock (125 MHz) output.
ETH-RST	JB3-53	-
RGMII	JB3-31 JB3-37 - JB-44 JB3-47 JB3-57 - JB-59	Reduced Gigabit Media Independent Interface. 12 pins. <div>  ETH-RXCK is connected via 0Ohm to JB3-31 (R18) and JB3-58 (R19). Usage depends on Module and AMD IP restrictions In case of performance problems remove 0Ohm resistor from the unused Pin. </div>
SGMII	-	Serial Gigabit Media Independent Interface. Not connected.
MDI	-	Media Dependent Interface. Connected to Gigabit Ethernet MagJack J2 .

RJ45 connectors

SDIO Port Expander

The TE0706 Carrier Board is equipped with a Texas Instruments [TXS02612](#) SDIO Port Expander, which is needed for voltage translation due to different voltage levels of the Micro SD Card and the PS MIO-bank of the Zynq device of the mounted SoM. The Micro SD Card has 3.3V signal voltage level, but the PS MIO-bank on the AMD Zynq module has VCCIO of 1.8V or 3.3V depending on the attached module. This has to be selected by [J13](#).

SD-Card Signal Schematic Name	SD-Card Connected to	Connected to	SD IO Signal Schematic Name	B2B	Note
eSD_DAT0	U4-18	U4-6	SD_DAT0	JB1-24	SD IO data
eSD_DAT1	U4-16	U4-7	SD_DAT1	JB1-22	SD IO data
eSD_DAT2	U4-23	U4-1	SD_DAT2	JB1-20	SD IO data
eSD_DAT3	U4-22	U4-3	SD_DAT3	JB1-18	SD IO data
eSD_CLK	U4-19	U4-9	SD_CLK	JB1-28	SD IO clock
eSD_CMD	U4-20	U4-4	SD_CMD	JB1-26	SD IO command
MIO0	-	-	-	JB1-88	Card Detect signal

SDIO Port Expander

Power and Power-On Sequence

Power Supply

Power supply with minimum current capability of 3A for system startup is recommended.

Power Consumption

The maximum power consumption of the Carrier Board depends mainly on the mounted SoM's FPGA design running on the Zynq device.

AMD provide a power estimator excel sheets to calculate power consumption. It's also possible to evaluate the power consumption of the developed design with Vivado. See also [Trenz Electronic Wiki FAQ](#).

Power Input Pin	Typical Current
VIN	TBD*
VBAT	TBD*

Power Consumption

* TBD - To Be Determined.

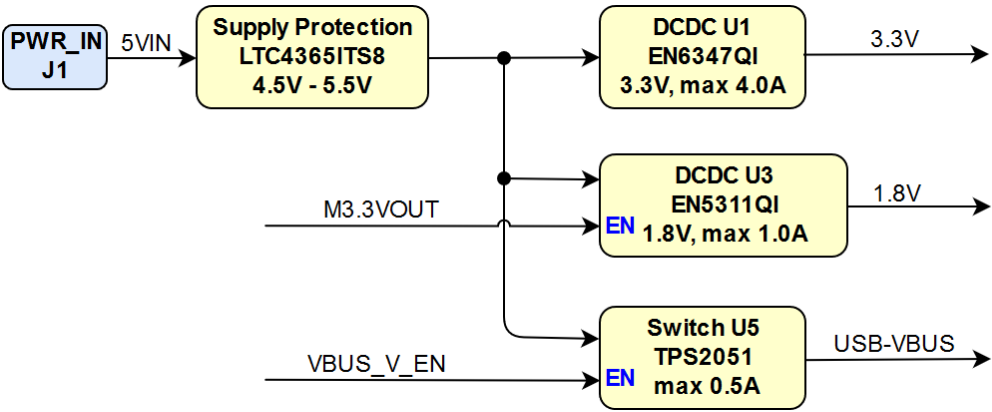
Power supply with minimum current capability of 3A for system startup is recommended.



To avoid any damage to the module, check for stabilized on-board voltages and VCCIOs before put voltages on PL I/O-banks and interfaces. All I/Os should be tri-stated during power-on sequence.

Power Distribution Dependencies

The Carrier Board needs one single power supply voltage with a nominal value of 5V. Following diagram shows the distribution of the input voltage '5VIN' to the on-board components on the mounted SoM:



Power Distribution

Power Rails

The voltage direction of the power rails is directed at on-board connectors' view:

Module Connector (B2B) Designator	VCC / VCCIO	Direction	Pins	Notes
JB1	3.3V	Out	2, 4, 6, 14, 16	3.3V module supply voltage
	VCCIOA	Out	10, 12	PL IO-bank VCCIO
	M1.8VOUT	In	40	1.8V module output voltage
	VBAT	Out	80	RTC buffer voltage
JB2	1.8V	Out	2, 4	1.8V module supply voltage
	VCCIOB	Out	6	PL IO-bank VCCIO
	VCCIOC	Out	8, 10	PL IO-bank VCCIO
	M3.3VOUT	In	9, 11	3.3V module output voltage
	VCCJTAG	In	92	3.3V JTAG VCCIO

JB3	USB-VBUS	Out	56	USB Host supply voltage
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Power pin description of B2B module connectors.

On-board Connector Designator	VCC / VCCIO	Direction	Pins	Notes
J5	3.3V	Out	6, 45	3.3V module supply voltage
	M3.3VOUT	Out	5, 46	3.3V module output voltage
J6	VCCIOA	Out / In	B32	PL IO-bank VCCIO, depends on Jumper settings
	VCCIOC	Out / In	B1	PL IO-bank VCCIO, depends on Jumper settings
	M3.3VOUT	Out	C32	3.3V module output voltage
	3.3V	Out	C31	3.3V module supply voltage
	5VIN	Out	A1, A2	Carrier Board supply power

Power Pin description of on-board connector.

Jumper / Header Designator	VCC / VCCIO	Direction	Pins	Notes
J10	VCCIOA	In	2	-
	1.8V	Out	1	-
	M3.3VOUT	Out	3	-
J11	VCCIOB	In	2	-
	1.8V	Out	1	-
	M3.3VOUT	Out	3	-
J12	VCCIOC	In	2	-
	1.8V	Out	1	-
	M3.3VOUT	Out	3	-

Power Pin description of VCCIO selection jumper pin header

Main Power Jack and Pins Designator	VCC / VCCIO	Direction	Pins	Notes
J1	5VIN	In	1	Power Jack 2.1mm 90° SMD
J9	VBAT	In	1	Attention: Pin 2 connected to ground. VBAT voltage connected on this pin cause short-circuit.

Main Power jack and pins description.


Peripheral Socket Designator	VCC / VCCIO	Direction	Pins	Notes
J7 / J8	USB-VBUS	In / Out	1	Direction depends on USB mode
J4	M3.3VOUT	Out	4	MikroSD Card socket VDD

Power pin description of peripheral connector.

XMOD Header Designator	VCC / VCCIO	Direction	Pins	Notes
JX1	3.3V	-	5	not connected
	VIO	Out	6	connected to 'VCCJTAG' (pin JB2-92)

Power pin description of XMOD/JTAG Connector.

Board to Board Connectors

 These connectors are hermaphroditic. Odd pin numbers on the module are connected to even pin numbers on the baseboard and vice versa.

4 x 5 modules use two or three [Samtec Razor Beam LSHM connectors](#) on the bottom side.

- 2 x REF-189016-02 (compatible to LSHM-150-04.0-L-DV-A-S-K-TR), (100 pins, "50" per row)
- 1 x REF-189017-02 (compatible to LSHM-130-04.0-L-DV-A-S-K-TR), (60 pins, "30" per row) (depending on module)

Connector Mating height

When using the same type on baseboard, the mating height is 8mm. Other mating heights are possible by using connectors with a different height

Order number	Connector on baseboard	compatible to	Mating height
23836	REF-189016-01	LSHM-150-02.5-L-DV-A-S-K-TR	6.5 mm
	LSHM-150-03.0-L-DV-A-S-K-TR	LSHM-150-03.0-L-DV-A-S-K-TR	7.0 mm
23838	REF-189016-02	LSHM-150-04.0-L-DV-A-S-K-TR	8.0 mm
	LSHM-150-06.0-L-DV-A-S-K-TR	LSHM-150-06.0-L-DV-A-S-K-TR	10.0mm
26125	REF-189017-01	LSHM-130-02.5-L-DV-A-S-K-TR	6.5 mm
	LSHM-130-03.0-L-DV-A-S-K-TR	LSHM-130-03.0-L-DV-A-S-K-TR	7.0 mm
24903	REF-189017-02	LSHM-130-04.0-L-DV-A-S-K-TR	8.0 mm
	LSHM-130-06.0-L-DV-A-S-K-TR	LSHM-130-06.0-L-DV-A-S-K-TR	10.0mm

Connectors.

The module can be manufactured using other connectors upon request.

Connector Speed Ratings

The LSHM connector speed rating depends on the stacking height; please see the following table:

Stacking height	Speed rating
12 mm, Single-Ended	7.5 GHz / 15 Gbps
12 mm, Differential	6.5 GHz / 13 Gbps
5 mm, Single-Ended	11.5 GHz / 23 Gbps
5 mm, Differential	7.0 GHz / 14 Gbps

Speed rating.

Current Rating

Current rating of [Samtec Razor Beam™ LSHM B2B connectors](#) is 2.0A per pin (2 adjacent pins powered).

Connector Mechanical Ratings

- Shock: 100G, 6 ms Sine
- Vibration: 7.5G random, 2 hours per axis, 3 axes total

Manufacturer Documentation

File	Modified
PDF File hsc-report_lshm-lshm-05mm_web.pdf High speed test report	07 04, 2016 by Thorsten Trenz
PDF File lshm_dv.pdf LSHM catalog page	07 04, 2016 by Thorsten Trenz
PDF File LSHM-1XX-XX.X-X-DV-A-X-X-TR-FOOTPRINT(1).pdf Recommended layout and stencil drawing	07 04, 2016 by Thorsten Trenz
PDF File LSHM-1XX-XX.X-XX-DV-A-X-X-TR-MKT.pdf Technical drawing	07 04, 2016 by Thorsten Trenz
PDF File REF-189016-01.pdf Technical Drawing	07 04, 2016 by Thorsten Trenz
PDF File REF-189016-02.pdf Technical Drawing	07 04, 2016 by Thorsten Trenz
PDF File REF-189017-01.pdf Technical Drawing	07 04, 2016 by Thorsten Trenz
PDF File REF-189017-02.pdf Technical Drawing	07 04, 2016 by Thorsten Trenz
PDF File TC0923--2523_report_Rev_2_qua.pdf Design qualification test report	07 04, 2016 by Thorsten Trenz
PDF File tc0929--2611_qua(1).pdf Shock and vibration report	07 04, 2016 by Thorsten Trenz

[Download All](#)

Technical Specifications

Absolute Maximum Ratings

Parameter	Min	Max	Units	Reference Document
5VIN supply voltage	-0.3	7	V	MP5010A, EN6347QI, EN5311QI data sheet
Storage temperature	-55	+85	°C	Marvell 88E1512 data sheet

Power System absolute maximum ratings

Recommended Operating Conditions

Operating temperature range depends also on customer design and cooling solution. Please contact us for options.

Parameter	Min	Max	Units	Reference Document
5VIN supply voltage	4.75	5.25	V	USB2.0 specification concerning 'VBUS' voltage
Operating temperature	-40	+85	°C	-

Recommended operating conditions.

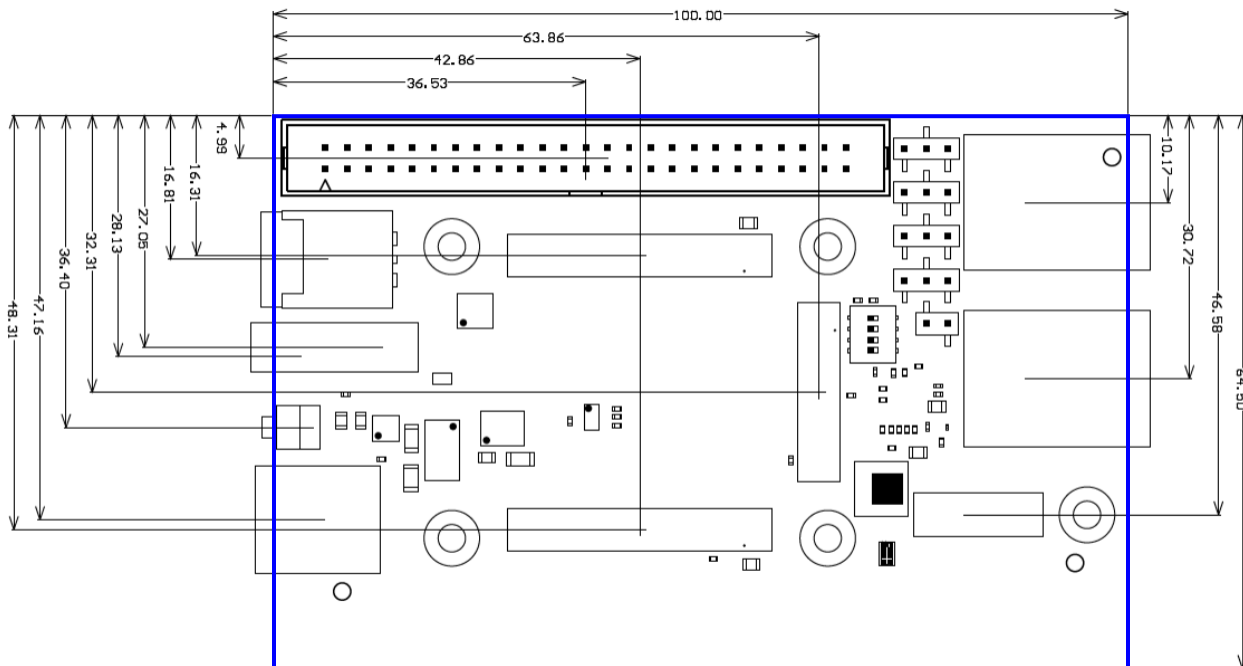
The TE0706 Carrier Board itself is capable to be operated at industrial grade temperature range (-40 °C ..+85 °C).

Please check the operating temperature range of the mounted SoM, which determine the relevant operating temperature range of the overall system.

Physical Dimensions

- Board size: PCB 100mm × 64.5mm. Notice that the USB type A socket on the left and the Ethernet RJ-45 jacks on the right are hanging slightly over the edge of the PCB making the total width of the longer side approximately 106mm. Please download the assembly diagram for exact numbers.
- Mating height of the module with standard connectors: 8mm
- PCB thickness: 1.65mm
- Highest parts on the PCB are USB type A socket and the Ethernet RJ-45 jacks, approximately 15mm. Please download the step model for exact numbers.

All dimensions are given in millimeters.



Physical Dimension

Currently Offered Variants

Trenz shop TE0728 overview page	
English page	German page
Trenz Electronic Shop Overview	

Revision History

Hardware Revision History

List of online PCNs can be found [here](#).

Date	Revision	Notes	Documentation Link
2016-06-28	01	<ul style="list-style-type: none">• Prototypes	TE0706-01
-	02	<ul style="list-style-type: none">• First Production Release• Refer to Changes list in Schematic for further details in changes to REV01	TE0706-02
2019-04-11	03	<ul style="list-style-type: none">• all components are industrial temperature range• added SDIO Levelshifter	TE0706-03

Hardware Revision History

Hardware revision number can be found on the PCB board together with the module model number separated by the dash.



Board hardware revision number.

Document Change History

Date	Revision	Contributors	Description
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<p>Error rendering macro 'page-info'</p> <p>Ambiguous method overloading for method jdk.proxy241.\$Proxy3496#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]</p>	<p>Error rendering macro 'page-info'</p> <p>Ambiguous method overloading for method jdk.proxy241.\$Proxy3496#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]</p>	<p>Error rendering macro 'page-info'</p> <p>Ambiguous method overloading for method jdk.proxy241.\$Proxy3496#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]</p>	<ul style="list-style-type: none"> ▪ Changed Xilinx to AMD. ▪ Updated to PCN-20231106.
2021-02-19	v.76	John Hartfiel	<ul style="list-style-type: none"> • Note to PHY connection
2010-07-16	v.74	John Hartfiel	<ul style="list-style-type: none"> • update Physical Dimensions
2019-05-27	v.73	Martin Rohrmüller	<ul style="list-style-type: none"> • Updated to REV03 • Updated to TRM v28
2018-06-03	v.66	John Hartfiel	<ul style="list-style-type: none"> • Add note to DIP settings

2017-11-10	v.64	John Hartfiel	<ul style="list-style-type: none"> • Replace B2B connector section
2017-11-09	v.60	Ali Naseri	<ul style="list-style-type: none"> • TRM revision to new common style
2017-07-06	v.52	Ali Naseri, Jan Kumann	<ul style="list-style-type: none"> • Hardware revision 02 specific changes.
2017-01-06	v.1	Ali Naseri	<ul style="list-style-type: none"> • initial document to board revision 02

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Document change history.

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02 Sept 2017